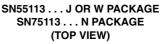
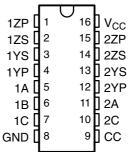
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- Choice of Open-Collector, Open-Emitter, or 3-State Outputs
- High-Impedance Output State for Party-Line Applications
- Single-Ended or Differential AND/NAND Outputs
- Single 5-V Supply
- Dual Channel Operation
- Compatible With TTL
- Short-Circuit Protection
- High-Current Outputs
- Common and Individual Output Controls
- Clamp Diodes at Inputs and Outputs
- Easily Adaptable to SN55114 and SN75114 Applications
- Designed for Use With SN55115 and SN75115

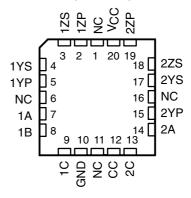
#### description

The SN55113 and SN75113 dual differential line drivers with 3-state outputs are designed to provide all the features of the SN55114 and SN75114 line drivers with the added feature of driver output controls. Individual controls are provided for each output pair, as well as a common control for both output pairs. If any output





# SN55113 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

is low, the associated output is in a high-impedance state and the output can neither drive nor load the bus. This permits many devices to be connected together on the same transmission line for party-line applications.

The output stages are similar to TTL totem-pole outputs, but with the sink outputs, YS and ZS, and the corresponding active pullup terminals, YP and ZP, available on adjacent package pins.

The SN55113 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN75113 is characterized for operation over the temperature range of 0°C to 70°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



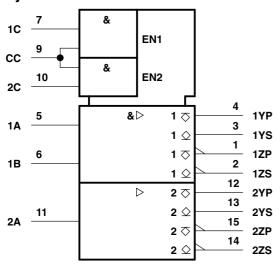
SLLS070C - SEPTEMBER 1973 - REVISED MARCH 1997

#### **FUNCTION TABLE**

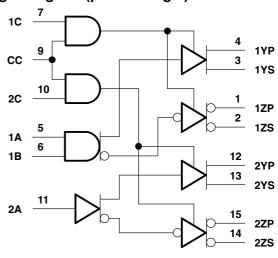
	INPUTS									
OUTPUT	CONTROL	DA	ATA	AND	NAND					
С	CC	Α	Βţ	Y	Z					
L	Х	Х	Χ	Z	Z					
Х	L	Χ	Χ	Z	Z					
Н	Н	L	Χ	L	Н					
Н	Н	Х	L	L	Н					
Н	Н	Н	Н	Н	L					

H = high level, L = low level, X = irrelevant,

# logic symbol‡



# logic diagram (positive logic)



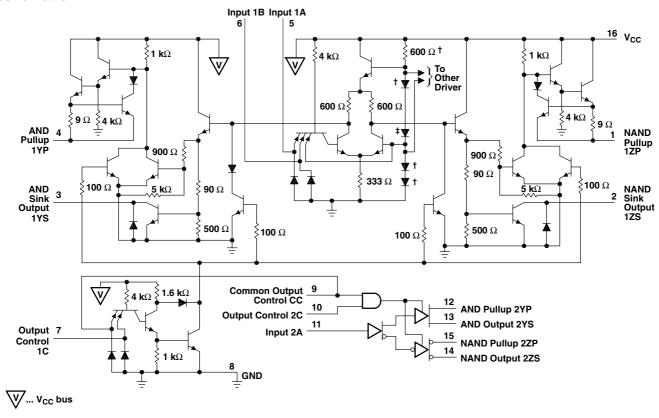
Pin numbers shown are for the J, N, and W packages.

Z = high impedance (off)

<sup>&</sup>lt;sup>†</sup> B input and 4th line of function table are applicable only to driver number 1.

<sup>&</sup>lt;sup>‡</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

#### schematic



<sup>&</sup>lt;sup>†</sup> These components are common to both drivers. Resistor values shown are nominal and in ohms.

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V <sub>CC</sub> (see Note 1)	
Input voltage, V <sub>I</sub>	5.5 V
Off-state voltage applied to open-collector outputs	12 V
Continuous total power dissipation (see Note 2)	See Dissipation Rating Table
Operating free-air temperature range, T <sub>A</sub> : SN55113	–55°C to 125°C
SN75113	0°C to 70°C
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: N package .	260°C
Case temperature for 60 seconds: FK package	260°C
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds: J or W package	ge300°C

<sup>&</sup>lt;sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## **DISSIPATION RATING TABLE**

PACKAGE	$T_A \le 25^{\circ}\text{C}$ DERATING FACTOR $T_A = 70^{\circ}\text{C}$ POWER RATING ABOVE $T_A = 25^{\circ}\text{C}$ POWER RATIN		T <sub>A</sub> = 70°C POWER RATING	T <sub>A</sub> = 125°C POWER RATING
FK	1375 mW	11.0 mW/°C	880 mW	275 mW
J	1375 mW	11.0 mW/°C	880 mW	275 mW
N	1150 mW	9.2 mW/°C	736 mW	N/A
W	1000 mW	8.0 mW/°C	640 mW	200 mW



# SN55113, SN75113 DUAL DIFFERENTIAL LINE DRIVERS

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## recommended operating conditions

	;	SN55113			SN75113			
	MIN	MIN NOM MAX MIN NOM MAX		MAX	UNIT			
Supply voltage, V <sub>CC</sub>	4.5	5	5.5	4.75	5	5.25	V	
High-level input voltage, V <sub>IH</sub>	2			2			V	
Low-level input voltage, $V_{\rm IL}$			8.0			8.0	V	
High-level output current, I <sub>OH</sub>			- 40			- 40	mA	
Low-level output current, I <sub>OL</sub>			40			40	mA	
Operating free-air temperature, T <sub>A</sub>	-55		125	0		70	°C	

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

						5	SN55113			N75113						
	PARAMETER	l	15	EST CONDITION	IST	MIN	TYP <sup>‡</sup>	MAX	MIN	TYP <sup>‡</sup>	MAX	UNIT				
$V_{IK}$	Input clamp vo	ltage	$V_{CC} = MIN,$	$I_1 = -12 \text{ mA}$			-0.9	-1.5		-0.9	-1.5	V				
.,	High-level out	out	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	$I_{OH} = -10 \text{ mA}$	2.4	3.4		2.4	3.4		.,				
V <sub>OH</sub>	voltage		$V_{IL} = 0.8 \text{ V}$		$I_{OH} = -40 \text{ mA}$	2	3.0		2	3.0		V				
V <sub>OL</sub>	Low-level outp	out	$V_{CC} = MIN,$ $I_{OL} = 40 \text{ mA}$	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> = 0.8 V,		0.23	0.4		0.23	0.4	٧				
V <sub>OK</sub>	Output clamp	voltage	$V_{CC} = MAX$ ,	$I_{O} = -40 \text{ mA}$			-1.1	-1.5		-1.1	-1.5	٧				
				V 40V	T <sub>A</sub> = 25°C		1	10								
	Off-state	a. starst	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	V <sub>OH</sub> = 12 V	T <sub>A</sub> = 125°C			200				^				
				$V_{CC} = MAX$		$T_A = 25^{\circ}C$					1	10	μА			
				V <sub>OH</sub> = 5.25 V	T <sub>A</sub> = 70°C						20					
	Off-state (high-impedance-state)			$T_A = 25^{\circ}C$ ,	$V_O = 0$ to $V_{CC}$			±10			±10					
			$V_{CC} = MAX$ ,		V <sub>O</sub> = 0			-150			-20	μА				
$I_{OZ}$			Output $T_A = MAX$	T MANY	$V_0 = 0.4 \text{ V}$			±80			±20					
	output current		0.8 V					IA = MAX	$V_0 = 2.4 \text{ V}$			±80			±20	
					$V_O = V_{CC}$			80			20					
	Input current	A, B, C						1			1					
I <sub>I</sub>	at maximum input voltage	СС	$V_{CC} = MAX$ ,	$V_1 = 5.5 \text{ V}$				2			2	mA				
	High-level	A, B, C	.,	V 04V				40			40					
- <sub>IH</sub>	input current	CC	$V_{CC} = MAX$ ,	V <sub>I</sub> = 2.4 V				80			80	μΑ				
	Low-level	A, B, C	\/ \ \AA\/	V <sub>I</sub> = 0.4 V				-1.6			-1.6	mA				
IIL	input current	CC	$V_{CC} = MAX$ ,	V <sub>1</sub> = 0.4 V				-3.2			-3.2	mA				
los	Short-circuit output current	§	V <sub>CC</sub> = MAX,	$V_O = 0$ ,	T <sub>A</sub> = 25°C	-40	-90	-120	-40	-90	-120	mA				
	Supply current	t	All inputs at 0	V, No load,	$V_{CC} = MAX$		47	65		47	65	mA				
I <sub>CC</sub>	(both drivers)		T <sub>A</sub> = 25°C		$V_{CC} = 7 V$		65	85		65	85	IIIA				

<sup>&</sup>lt;sup>†</sup> All parameters with the exception of off-state open-collector output current are measured with the active pullup connected to the sink output. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



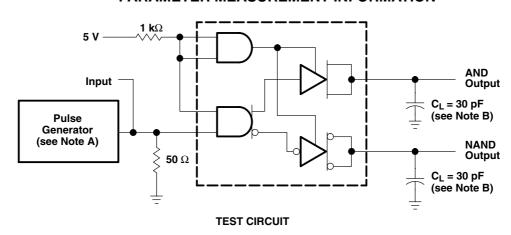
 $<sup>^\</sup>ddagger$  All typical values are at  $T_A$  = 25°C and  $V_{CC}$  = 5 V, with the exception of  $V_{CC}$  at 7 V.

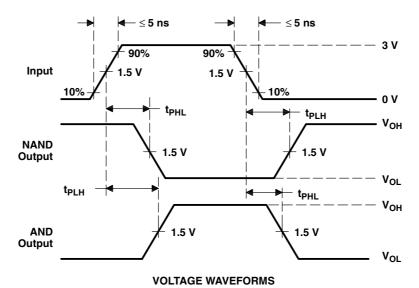
<sup>§</sup> Only one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

# switching characteristics, $V_{CC}$ = 5 V, $C_L$ = 30 pF, $T_A$ = 25°C

	DADAMETED	TEST CONDITIONS	SN55113 MIN TYP MAX			S	LINIT		
	PARAMETER	TEST CONDITIONS				MIN	TYP	MAX	UNIT
t <sub>PLH</sub>	Propagation delay time, low-to-high level output	Con Figure 4		13	20		13	30	ns
t <sub>PHL</sub>	Propagation delay time, high-to-low-level output	See Figure 1		12	20		12	30	ns
t <sub>PZH</sub>	Output enable time to high level	$R_L$ = 180 Ω, See Figure 2		7	15		7	20	ns
$t_{PZL}$	Output enable time to low level	$R_L$ = 250 Ω, See Figure 3		14	30		14	40	ns
t <sub>PHZ</sub>	Output disable time from high level	$R_L$ = 180 Ω, See Figure 2		10	20		10	30	ns
$t_{PLZ}$	Output disable time from low level	$R_L$ = 250 Ω, See Figure 3		17	35		17	35	ns

## PARAMETER MEASUREMENT INFORMATION





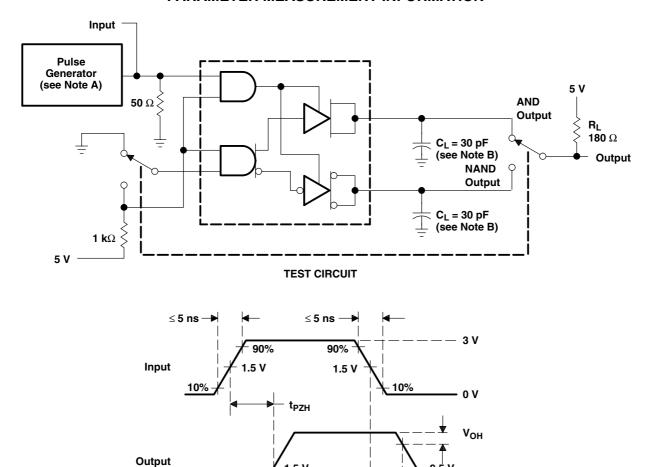
NOTES: A. The pulse generator has the following characteristics:  $Z_{O}$  = 50  $\Omega$ , PRR  $\leq$  500 kHz,  $t_{W}$  = 100 ns.

B. C<sub>L</sub> includes probe and jig capacitance.

Figure 1. Test Circuit and Voltage Waveforms t<sub>PLH</sub> and t<sub>PHL</sub>



## PARAMETER MEASUREMENT INFORMATION



**VOLTAGE WAVEFORMS** 

NOTES: A. The pulse generator has the following characteristics:  $Z_0 = 50 \ \Omega$ , PRR  $\leq 500 \ kHz$ ,  $t_w = 100 \ ns$ .

B. C<sub>L</sub> includes probe and jig capacitance.

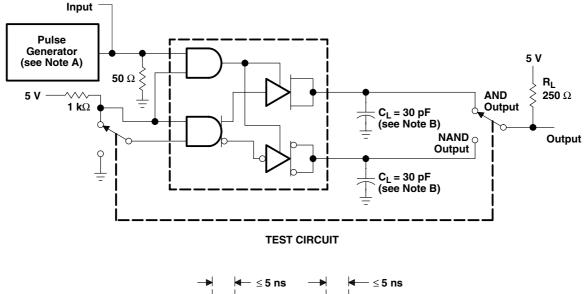
Figure 2. Test Circuit and Voltage Waveforms tpZH and tpHZ

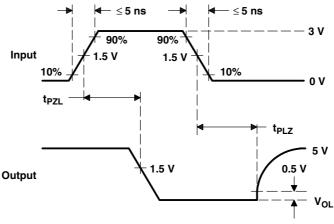
t<sub>PHZ</sub>

0.5 V

 $V_{off}\approx 0~V$ 

## PARAMETER MEASUREMENT INFORMATION



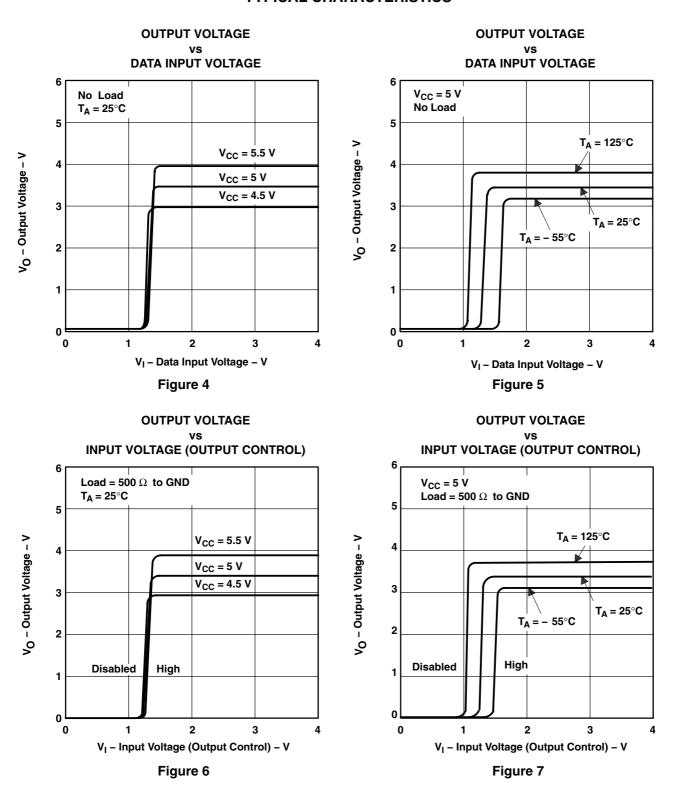


 $\label{eq:VOLTAGE WAVEFORMS}$  NOTES: A. The pulse generator has the following characteristics: Z<sub>O</sub> = 50  $\Omega$ , PRR  $\leq$  500 kHz, t<sub>W</sub> = 100 ns.

B. C<sub>L</sub> includes probe and jig capacitance.

Figure 3. Test Circuit and Voltage Waveforms, tpzL and tpLZ

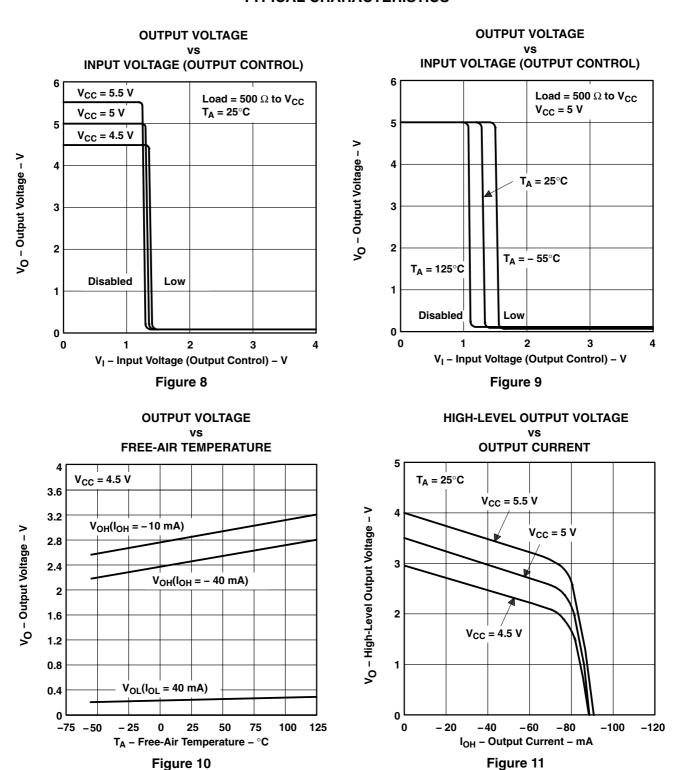
## TYPICAL CHARACTERISTICS†



<sup>&</sup>lt;sup>†</sup> Data for temperatures below 0°C and above 70°C and for supply voltages below 4.75 V and above 5.25 V are applicable to SN55113 circuits only. These parameters were measured with the active pullup connected to the sink output.



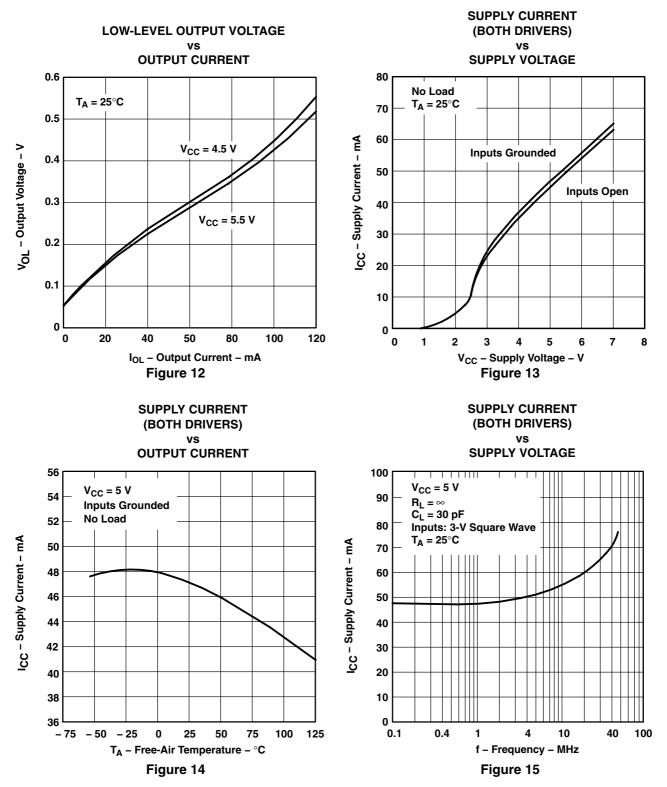
## TYPICAL CHARACTERISTICS†



<sup>&</sup>lt;sup>†</sup> Data for temperatures below 0°C and above 70°C and for supply voltages below 4.75 V and above 5.25 V are applicable to SN55113 circuits only. These parameters were measured with the active pullup connected to the sink output.



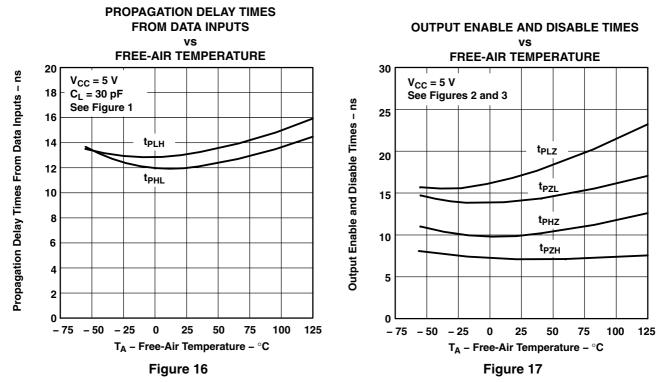
## TYPICAL CHARACTERISTICS<sup>†</sup>



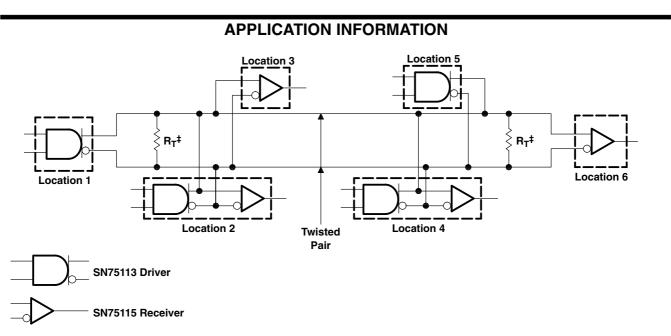
<sup>†</sup> Data for temperatures below 0°C and above 70°C and for supply voltages below 4.75 V and above 5.25 V are applicable to SN55113 circuits only. These parameters were measured with the active pullup connected to the sink output.



#### TYPICAL CHARACTERISTICS<sup>†</sup>



<sup>&</sup>lt;sup>†</sup> Data for temperatures below 0°C and above 70°C and for supply voltages below 4.75 V and above 5.25 V are applicable to SN55113 circuits only. These parameters were measured with the active pullup connected to the sink output.



 $^{\ddagger}$  R<sub>T</sub> = Z<sub>O</sub>. A capacitor may be connected in series with R<sub>T</sub> to reduce power dissipation.

Figure 18. Basic Party-Line or Data-Bus Differential Data Transmission







6-Feb-2020

## **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-88744012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 88744012A SNJ55 113FK	Samples
5962-8874401EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8874401EA SNJ55113J	Samples
5962-8874401FA	ACTIVE	CFP	W	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8874401FA SNJ55113W	Samples
JM38510/10405BEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510 /10405BEA	Samples
M38510/10405BEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	JM38510 /10405BEA	Samples
SN55113J	ACTIVE	CDIP	J	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN55113J	Samples
SN75113N	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN75113N	Samples
SN75113NE4	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN75113N	Samples
SN75113NSR	ACTIVE	so	NS	16	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75113	Samples
SNJ55113FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 88744012A SNJ55 113FK	Samples
SNJ55113J	ACTIVE	CDIP	J	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8874401EA SNJ55113J	Samples
SNJ55113W	ACTIVE	CFP	W	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8874401FA SNJ55113W	Samples

<sup>&</sup>lt;sup>(1)</sup> The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.



## PACKAGE OPTION ADDENDUM

6-Feb-2020

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN55113, SN75113:

Catalog: SN75113

www.ti.com

Military: SN55113

NOTE: Qualified Version Definitions:

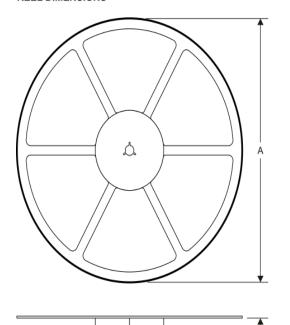
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

# PACKAGE MATERIALS INFORMATION

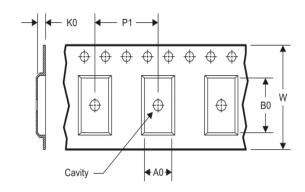
www.ti.com 14-Jul-2012

## TAPE AND REEL INFORMATION

## REEL DIMENSIONS



## TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

## TAPE AND REEL INFORMATION

## \*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75113NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 14-Jul-2012



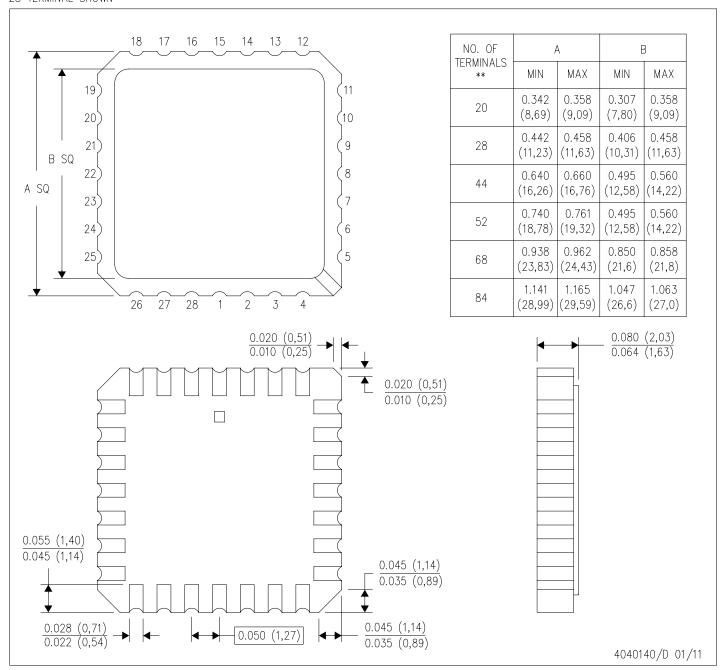
#### \*All dimensions are nominal

ĺ	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
	SN75113NSR	SO	NS	16	2000	367.0	367.0	38.0

# FK (S-CQCC-N\*\*)

# LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



## **MECHANICAL DATA**

# NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

## PLASTIC SMALL-OUTLINE PACKAGE

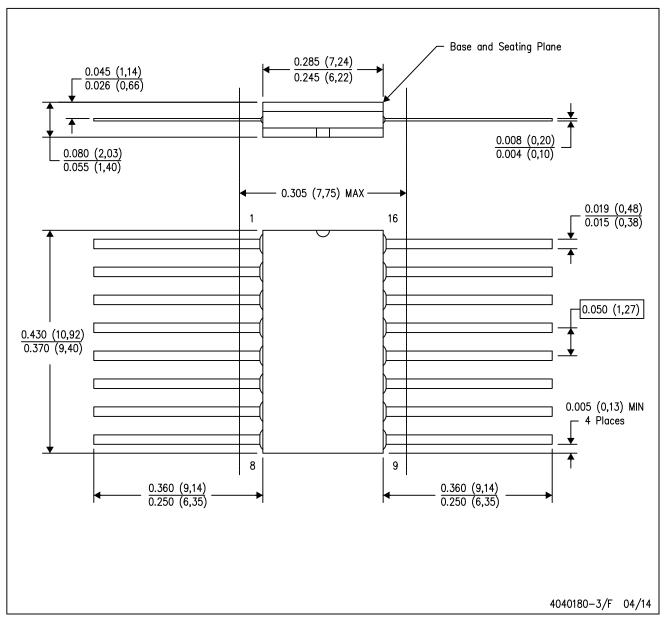


- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



# W (R-GDFP-F16)

# CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP2-F16



## 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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